

User's Manual (SMDK2416)

S3C2416X

RISC Microprocessor

Mar 17, 2008

Preliminary REV 0.0

Preliminary product information describe products that are in development, for which full characterization data and associated errata are not yet available. Specifications and information herein are subject to change without notice.

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S3C2416 RISC Microprocessor **SMDK2416 User's manual, Preliminary Revision 0.0**

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Revision No	Description of Change	Refer to	Author(s)	Date
0.0	- Initial Release	-		Mar 17, 2008

NOTE: Revised parts are written in blue.

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ABOUT SMDK2416 BOARD VER 0.0

SMDK2416 CPU and Base board revision number.

CPU Board Version	Rev 0.0
Base Board Version	Rev 0.0

SYSTEM OVERVIEW

This user's manual describes SAMSUNG's S3C2416 16/32-bit RISC microprocessor. SAMSUNG's S3C2416 is designed to provide hand-held devices and general applications with low-power, and high-performance micro-controller solution in small die size. To reduce total system cost, the S3C2416 includes the following components.

The S3C2416 is developed with ARM926EJ core, 65nm CMOS standard cells and a memory complier. Its low-power, simple, elegant and fully static design is particularly suitable for cost- and power-sensitive applications. It adopts a new bus architecture known as Advanced Micro controller Bus Architecture (AMBA). The S3C2416 offers outstanding features with its CPU core, a 16/32-bit ARM926EJ RISC processor designed by Advanced RISC Machines, Ltd. The ARM926EJ implements MMU, AMBA BUS, and Harvard cache architecture with separate 16KB instruction and 16KB data caches, each with an 8-word line length.

By providing a complete set of common system peripherals, the S3C2416 minimizes overall system costs and eliminates the need to configure additional components. The integrated on-chip functions that are described in this document include:

S3C2416 OVERVIEW

The S3C2416 (2416 Development Kit) highlights the basic system-based hardware design which uses the S3C2416. It can evaluate the basic operations of the S3C2416 and assist in developing codes.

S3C2416 is manufactured by **MERITECH Co., Ltd** and company website is www.mcukorea.com

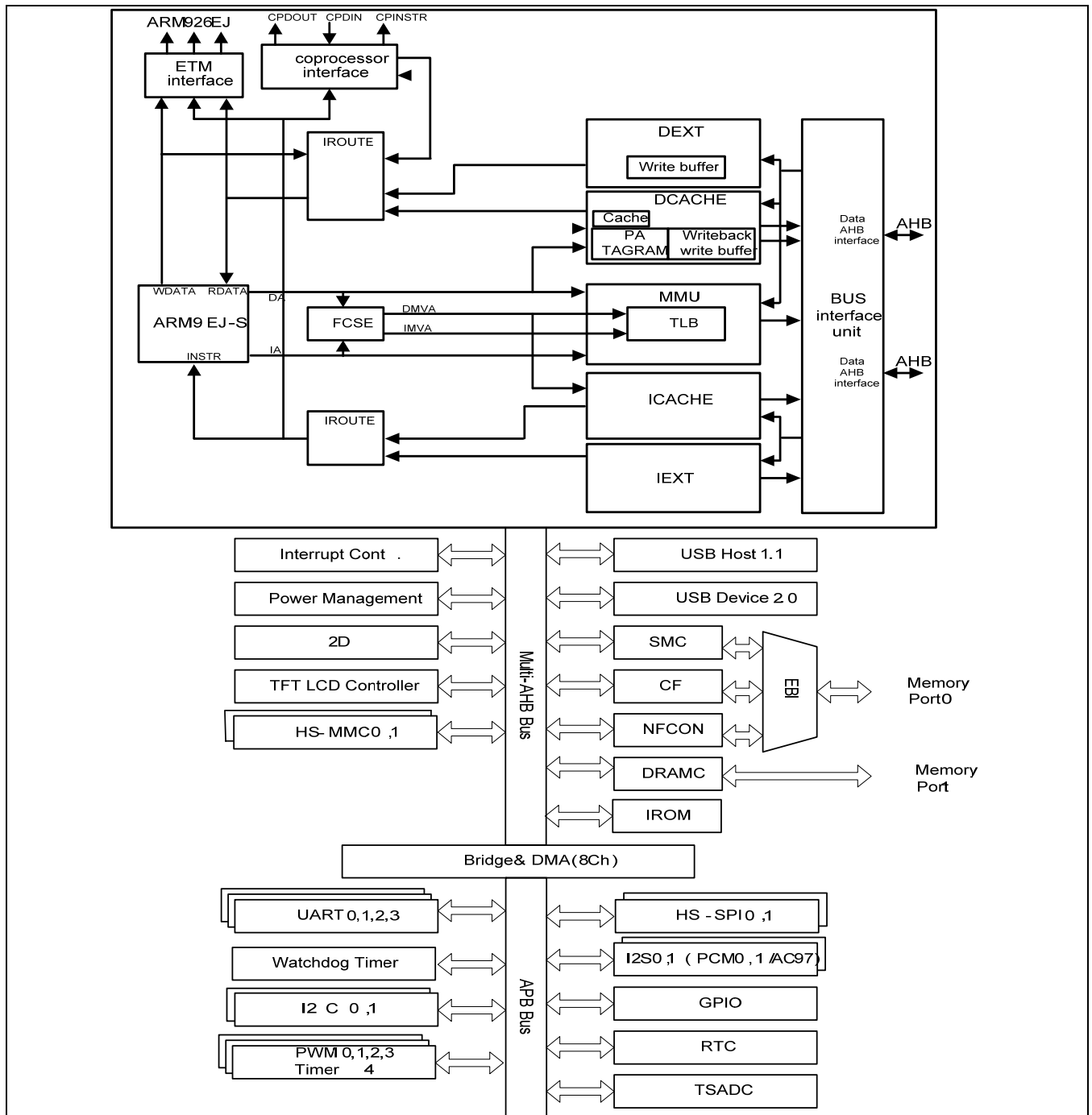


Figure 1 S3C2416 Block Diagram

FEATURES

The features of SMDK2416 include:

- S3C2416 : 16/32 bit RISC microcontroller
- X-tal operation or oscillator
- Boot Device : AMD 8Mbit 1EA
- SAMSUNG NAND flash 1EA(socket)
- SAMSUNG OneNAND 1EA(External Board)
- Internal ROM
- SDRAM : 64MB mDDR(K4X51163)
64MB DDR2(K4T51163QC)
64MB mSDR(K4S51323PF)
- JTAG port
- RTC X-tal input
- QVGA, WVGA LCD & Touch panel interface
- ADC interface
- USB Host, USB OTG 2.0 interface
- High Speed MMC interface
- High Speed SPI interface
- 2 port UART interface(including IrDA)
- IIS/AC97/PCM Interface : WM9714, WM8753, WM8580
- EINT interface
- Ethernet Interface : CS8900, LAN9115
- CF/ATA interface
- Keypad interface
- SD/MMC interface
- XD Card interface
- External PMIC Module

CIRCUIT DESCRIPTION

POWER SUPPLY

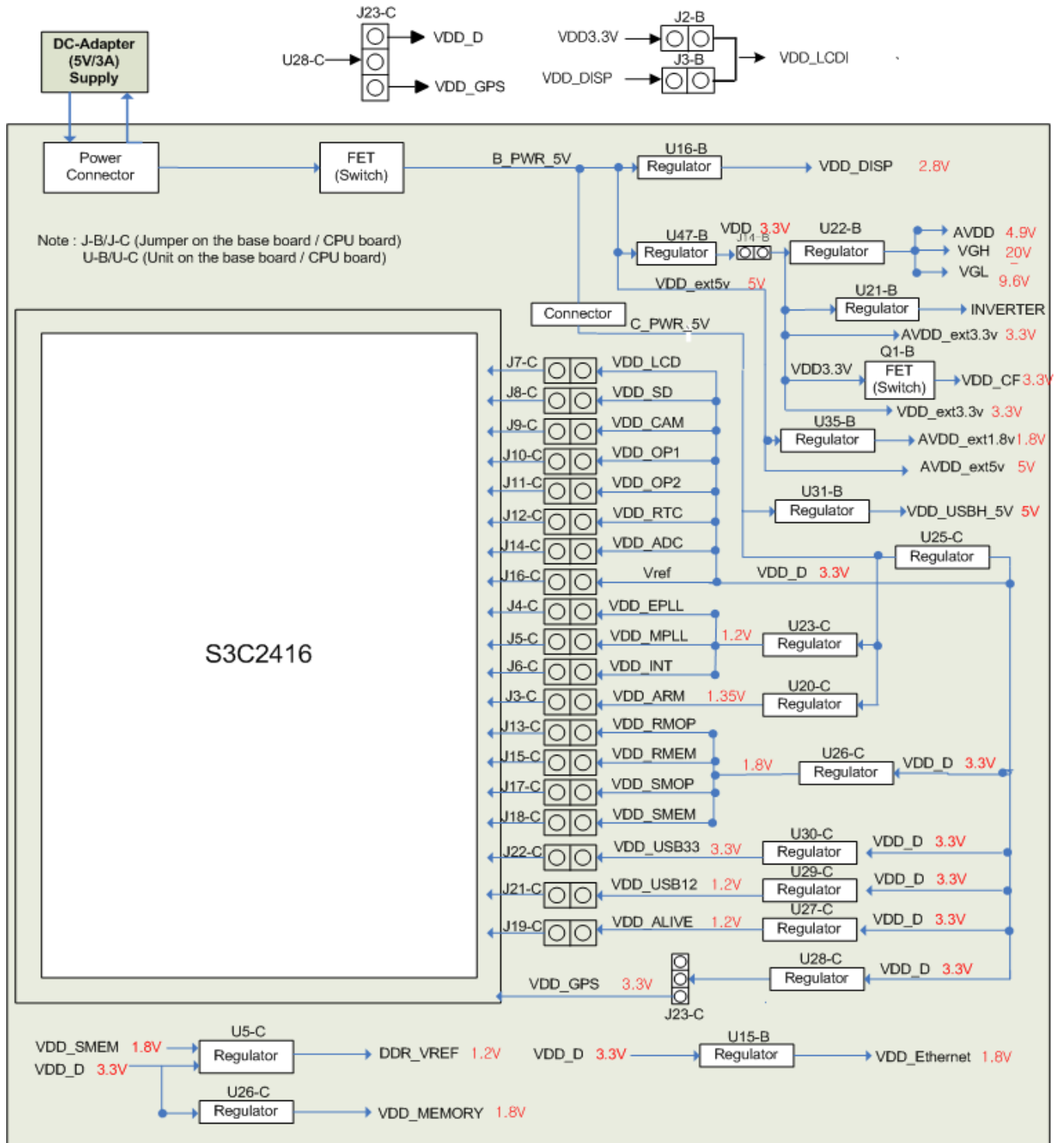


Figure 2 SMDK2416 Power Plane

BOARD DIAGRAM

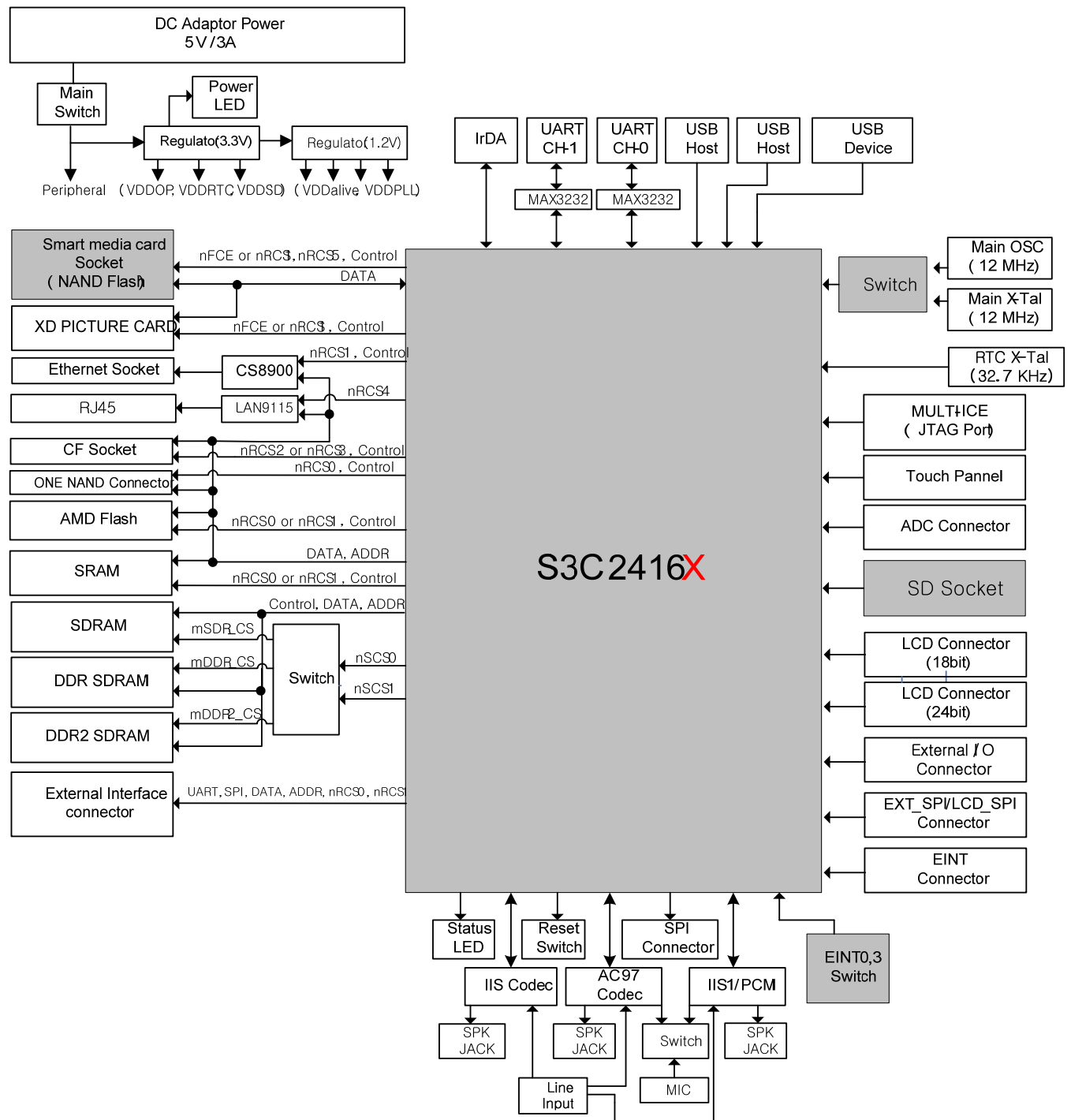


Figure 3 SMDK2416 Board Diagram

SMDK2416 CPU BOARD TYPE1 REAL VIEW

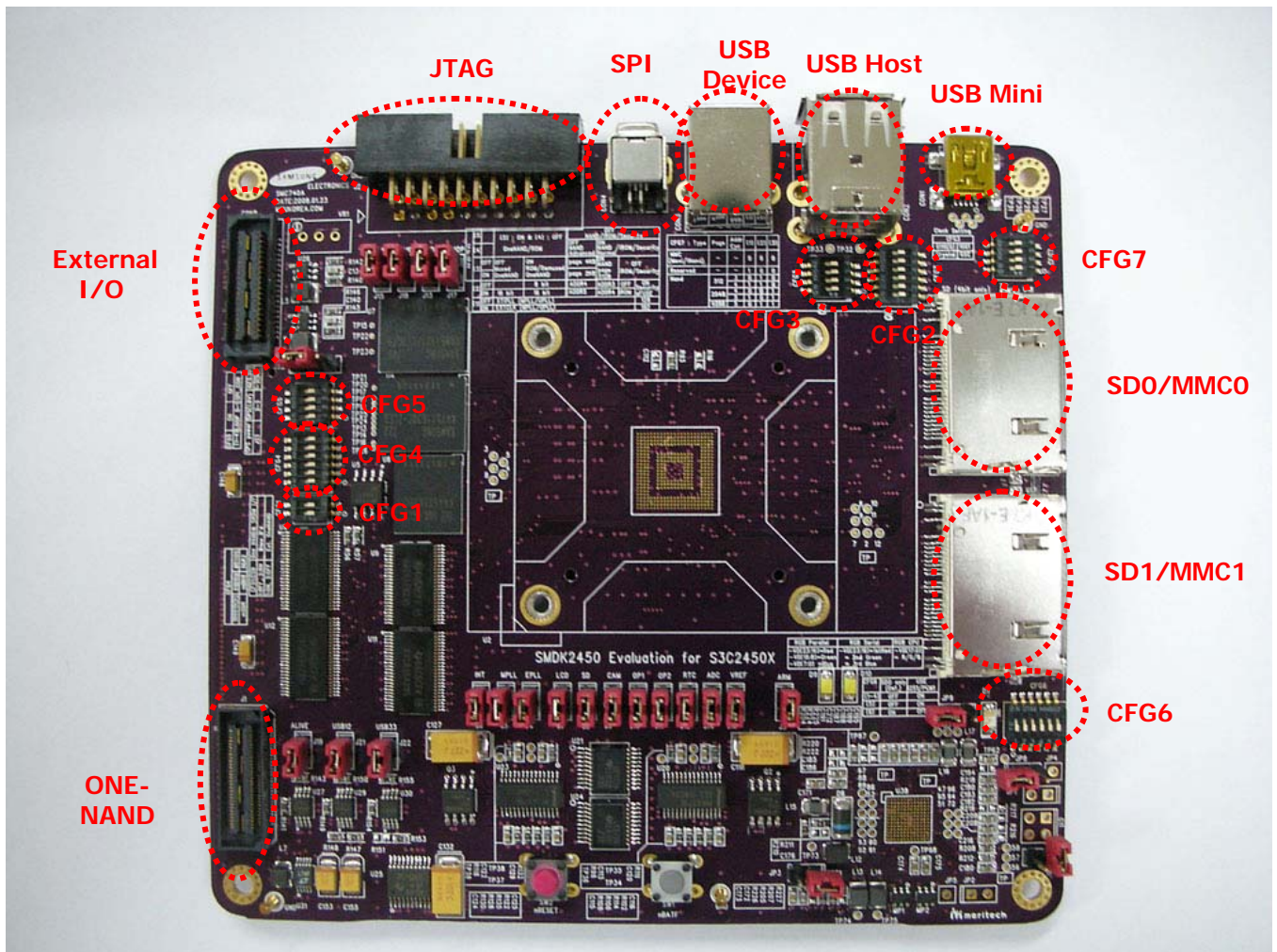


Figure 4 SMDK2416 CPU Board Type1 real view

SMDK2416 BASE BOARD REAL VIEW

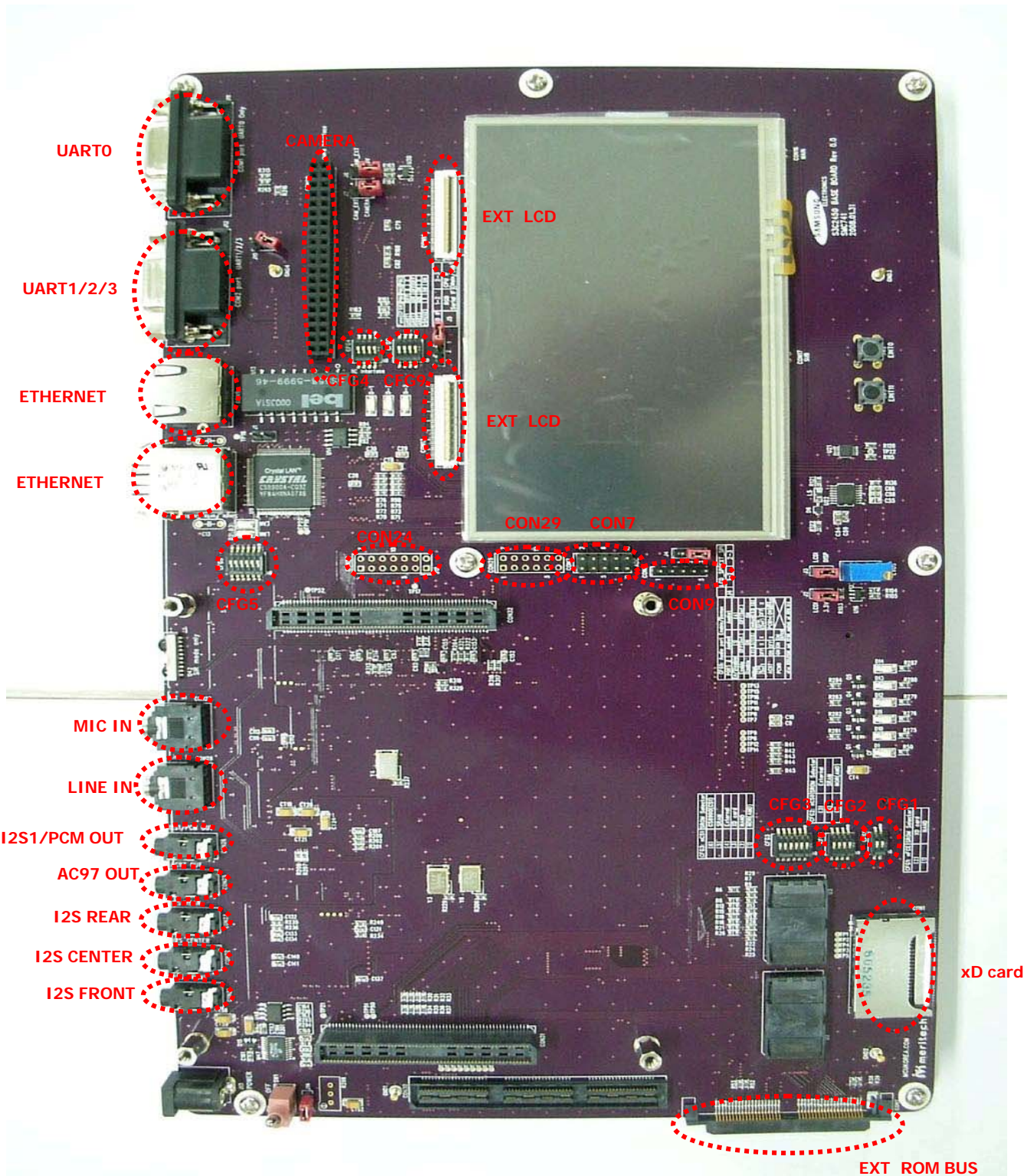


Figure 5 SMDK2416 BASE Board real view (TOP)

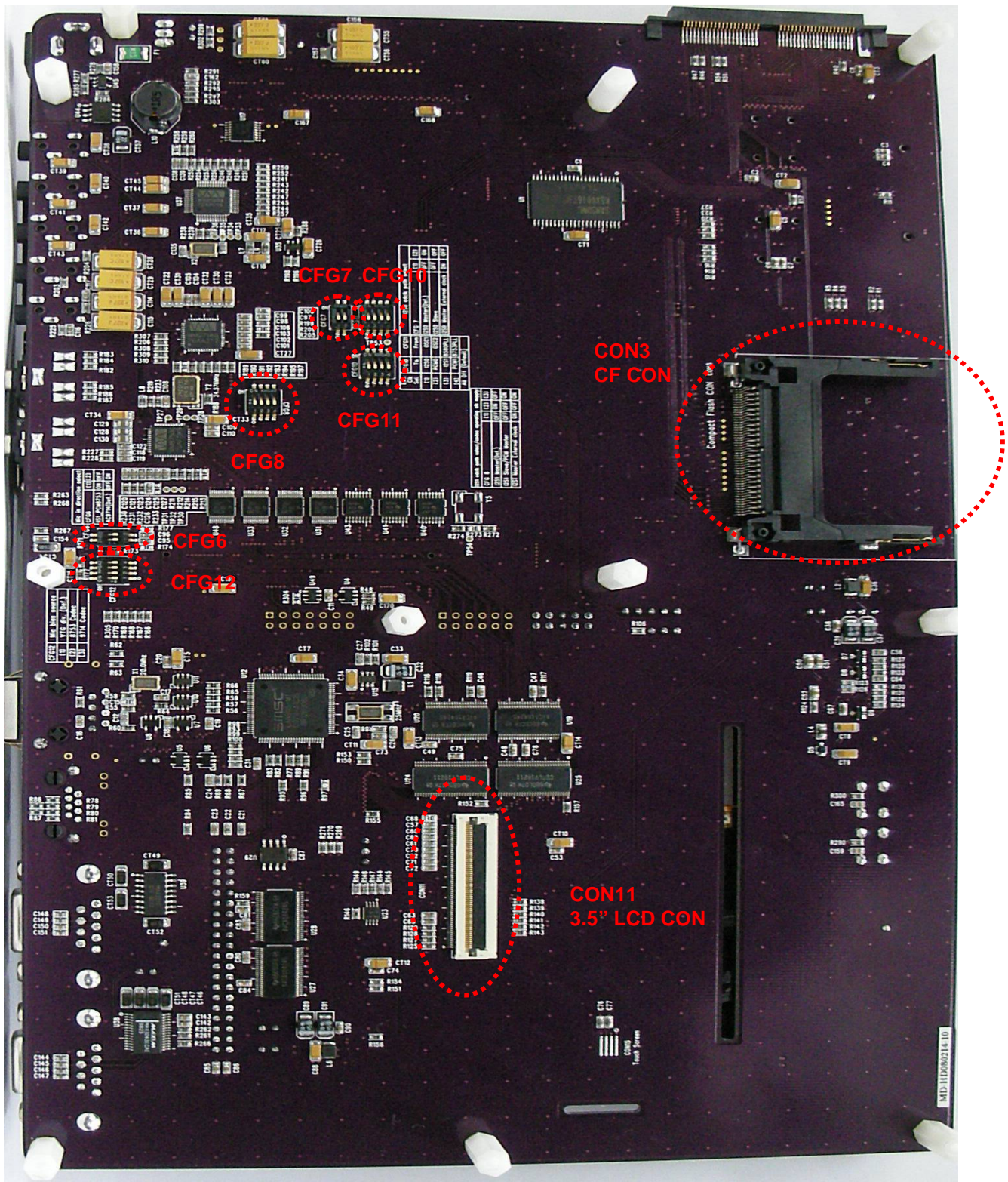
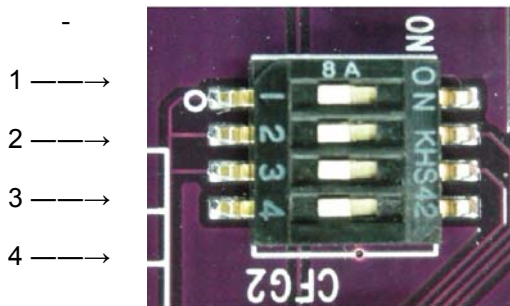


Figure 6 SMDK2416 BASE Board real view (BOTTOM)

SMDK2416 SYSTEM CONFIGURATIONS rev0.0

Configuration switch (Dipswitch)



Off ———> On

CLOCK SOURCE SELECTION

EXTCLK or X-TAL can be selected for the S3C2416 system clock by setting the XOM[0] values.

The Clock Source selection must be X-tal Clock (CFG2[1] on CPU Board).

<i>Description</i>	CFG2[1]_CPU : XOM[0]
External Oscillator Clock	ON
X-tal Clock	OFF

<i>Description</i>	CFG3[1:4]_CPU			
	[1]	[2]	[3]	[4]
External Oscillator Clock	ON	OFF	OFF	ON
X-tal Clock	OFF	ON	ON	OFF

BOOT MODE SELECTION

1. NAND Boot

- A. Set CFG0 on CPU Board, Select NAND Type
- B. Set CFG1 on Base Board, Select NAND flash or XD Picture card

<i>Description</i>	CFG2[2:6]_CPU : XOM[1]~ XOM[4]			
	[2]	[3]	[4]	[5]
Normal NAND, 512-byte page, 3 addr. Cycle	OFF	ON	ON	OFF
Normal NAND, 512-byte page, 4 addr. Cycle	ON	ON	ON	OFF
Advanced NAND, 2K-byte page, 4 addr. Cycle	OFF	ON	OFF	OFF
Advanced NAND, 2K-byte page, 5 addr. Cycle	ON	ON	OFF	OFF
Advanced NAND, 4K-byte page, 4 addr. Cycle	OFF	OFF	OFF	OFF
Advanced NAND, 4K-byte page, 5 addr. Cycle	ON	OFF	OFF	OFF

Note. NAND Boot is connected on nFCE. It is selected one between NAND Flash and XD Picture card.

<i>Description</i>	CFG1 [1:2] _CPU	
	[1]	[2]
Connected NandFlash to B_nFCE	ON	OFF
Connected XD Picture Card to B_nFCE	OFF	ON

2. Muxed OneNAND Boot

- A. Set CFG2 on CPU Board, Select OneNAND
- B. Set CFG1 on CPU Board, Select OneNAND
- C. SMDK2416 support external OneNAND Board, Connect it on J1 connector on CPU Board

<i>Description</i>	CFG2 [2:5]_CPU
--------------------	----------------

	[2]	[3]	[4]	[5]
OneNAND (used External OneNAND B'd)	ON	OFF	OFF	ON

Note. EXT_One NAND Boot is connected on nRCS0. It is selected one between EXT_One NAND Flash and AMD Flash or SRAM or EXT Device.

<i>Description</i>	CFG1 [1:2]_CPU	
	[1]	[2]
Connected EXT_One NAND to nRCS0	ON	OFF
Connected AMD or SRAM or EXT to nRCS0	OFF	ON

3. JTAG Mode

- A. Set CFG2 on CPU Board, Select JTAG Mode

<i>Description</i>	CFG2[1:5]_CPU				
	[1]	[2]	[3]	[4]	[5]
JTAG Mode	ON	OFF	OFF	OFF	ON

4. AMD NOR/SROM Boot

- A. Set CFG2 on CPU Board, Select Data width
B. Set CFG2 on Base Board, Select NOR flash

<i>Description</i>	CFG2[2:5]_CPU			
	[2]	[3]	[4]	[5]
NOR Boot (8bit Data Width)	OFF	ON	OFF	ON
NOR Boot (16bit Data Width)	ON	ON	OFF	ON

<i>Description</i>	CFG2[1:4]_BASE			
	[1]	[2]	[3]	[4]
Connected NOR Flash to B_SROM_nCS0	ON	OFF	OFF	Don't Care
Connected EXT to B_SROM_nCS0	OFF	ON	OFF	Don't Care
Connected SRAM to B_SROM_nCS0	OFF	OFF	ON	Don't Care

- **Note.** NOR Boot is connected to Bank0. Only NOR Flash can be used for NOR Boot

5. Internal ROM Boot

- Set CFG2 on CPU board, Select Internal ROM Boot
- Set CFG7_CPU to select Boot Device

<i>Description</i>	CFG2[1:5]_CPU				
	[1]	[2]	[3]	[4]	[5]
JTAG Mode	Don't Care	OFF	OFF	ON	OFF

<i>Description</i>	CFG7[1:4]_CPU			
	[1]	[2]	[3]	[4]
MMC (Movi / iNAND)	OFF	OFF	OFF	Don't Care
NAND 512 Page 3 Addr.	OFF	ON	OFF	Don't Care
NAND 512 Page 4 Addr.	ON	ON	OFF	Don't Care
NAND 2048 Page 4 Addr.	OFF	OFF	ON	Don't Care
NAND 2048 Page 5 Addr.	ON	OFF	ON	Don't Care
NAND 4096 Page 5 Addr.	OFF	ON	ON	Don't Care

CONFIGURATION SWITCH DESCRIPTION IN CPU BOARD

CFG4 _CPU: FOR USING SDRAM, MOBILE DDR SDRAM, DDR2 SDRAM

CFG4 component is used to select SDRAM, MOBILE DDR SDRAM, DDR2 SDRAM. Using 6 switches in this component, appropriate SDRAM type can be selected.

<i>Description</i>	CFG4[1:6]_CPU					
	[1]	[2]	[3]	[4]	[5]	[6]
Connected SDRAM to nCS0	ON	OFF	OFF	OFF	OFF	OFF
Connected Mobile DDR SDRAM to nCS0	OFF	ON	OFF	OFF	OFF	OFF
Connected DDR2 SDRAM to nCS0	OFF	OFF	ON	OFF	OFF	OFF
Connected SDRAM to nCS1	OFF	OFF	OFF	ON	OFF	OFF
Connected Mobile DDR SDRAM to nCS1	OFF	OFF	OFF	OFF	ON	OFF
Connected DDR2 SDRAM to nCS1	OFF	OFF	OFF	OFF	OFF	ON

CFG5 _CPU: FOR USING HS-SPI

CFG5 component is used to select HS-SPI Port. Using 2 switches in this component, appropriate HS-SPI can be selected.

<i>Description</i>	CFG5[1:4]_CPU			
	[1]	[2]	[3]	[4]
LCD_INIT(HS-SPI0 to HS-SPI1)	ON	ON	ON	ON
HS-SPI0 to CON4 (For B'd to B'd Connection)	OFF	OFF	OFF	OFF

CONFIGURATION SWITCH DESCRIPTION IN BASE BOARD

CFG2_BASE : SROM BANK0 SELECTOR

CFG2 component is used to select devices as SROM BUS I/F 0(B_SROM_nCS0).

<i>Description</i>	CFG2[1:3]_Base		
	[1]	[2]	[3]
NOR(AMD) Flash	ON	OFF	OFF
External Device	OFF	ON	OFF
SRAM	OFF	OFF	ON

CFG3_BASE : SROM BANK1 SELECTOR

CFG3 component is used to select devices as SROM BUS I/F 1(B_SROM_nCS1).

<i>Description</i>	CFG3[1:6]_Base					
	[1]	[2]	[3]	[4]	[5]	[6]
NOR (AMD) Flash	ON	OFF	OFF	OFF	OFF	OFF
NAND Flash	OFF	ON	OFF	OFF	OFF	OFF
XD Picture Card	OFF	OFF	ON	OFF	OFF	OFF
External Device	OFF	OFF	OFF	ON	OFF	OFF
SRAM	OFF	OFF	OFF	OFF	ON	OFF
CS8900	OFF	OFF	OFF	OFF	OFF	ON

CFG4_BASE: FOR USING IIC

CFG4 used to select IIC0 or IIC1.

<i>Description</i>	CFG4[1:4]_Base			
	[1]	[2]	[3]	[4]
For using IIC0	ON	OFF	ON	OFF
For using IIC1	OFF	ON	OFF	ON

CFG7_BASE : IIS0 CLOCK(CDCLK) SELECTOR

CFG7 component is used to select IIS0 CDCLK Selector.

<i>Description</i>	CFG7[1:2]_Base	
	[1]	[2]
I2S0 Master	OFF	ON
I2S0 Slave	OFF	OFF
I2S0 Master External Clock	ON	OFF

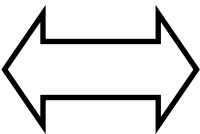
CFG8_BASE: IIS1 CLOCK(CDCLK) SELECTOR

CFG8 component is used to select IIS1 CDCLK Selector.

<i>Description</i>	CFG8[1:3]_Base		
	[1]	[2]	[3]
I2S1 Master	OFF	ON	OFF
I2S1 Slave	OFF	OFF	ON
I2S1 Master External Clock	ON	OFF	ON

CFG10 & CFG11_BASE : IIS & PCM EXTERNAL CLOCK SELECTOR

CFG10 & CFG11 component is used to select IIS Clock & PCM Clock. IIS External Clock & PCM External Clock. For IIS, IIS CDCLK Selector should be set as Master External Clock. OSC1 is designated typically for the 96KHz, PCM data and OSC2 is designated for 44.1KHz PCM data.

<i>Number</i>	CFG10_Base (To)		CFG11_Base (From)
[1]	IIS0		OSC1(36.864MHz)
[2]	PCM0		OSC2(16.9344MHz)
[3]	IIS1		8580 PLL Clock
[4]	PCM1		8753 PLL Clock

CFG6_BASE : MIC INDIRECTION SELECTOR

CFG6 component is used to select MIC Indirection.

<i>Description</i>	CFG6[1:2]_Base	
	[1]	[2]
IIS1 PCM8753	ON	OFF
AC9714	OFF	ON

CFG12_BASE : MIC BIAS SOURCE SELECTOR

CFG12 component is used to select MIC Bias source. To select MIC bias from Codec, appropriate Codec setting is needed.

<i>Description</i>	CFG12[1:4]_Base			
	[1]	[2]	[3]	[4]
VTG Div.	ON	OFF	OFF	Don't Care
8753 Codec	OFF	ON	OFF	Don't Care
9714 Codec	OFF	OFF	ON	Don't Care

CFG5 _BASE: AUDIO ENABLE SELECTOR & DEMUX SELECTOR

CFG5 component is used to select Audio Demux. Audio 0 port are composed of IIS0, AC97 and PCM0, and Audio 1 port are composed of IIS1, PCM1. Selecting one Audio IP is possible among port0 and port 1 , but also Selecting one Audio IP from port0, selecting one Audio IP from port1 at same time is possible. (except the PCM0 & PCM1 case). Before enabling Audio 1 port, **CFG6_CPU** must be set accordingly.

<i>Description</i>	CFG5_Base	
	[1]	[4]
Audio 0 Enable	OFF	ON
Audio 1 Enable	ON	OFF

<i>Description</i>	CFG5[1:6]_Base					
	[1]	[2]	[3]	[4]	[5]	[6]
IIS0	OFF	OFF	Don't Care	ON	Don't Care	Don't Care
AC97	OFF	ON	OFF	ON	Don't Care	Don't Care
PCM0	OFF	ON	ON	ON	Don't Care	ON
IIS1	ON	Don't Care	Don't Care	OFF	OFF	Don't Care
PCM1	ON	Don't Care	Don't Care	OFF	ON	OFF

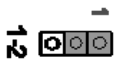
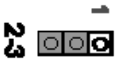
CFG9 _BASE: UART SELECTOR

CFG9 component is used to select UARTs. One of UART1~3 is selectable, (or none of them). IrDA is multiplexed with UART2, So simultaneously selecting with Uart1 or Uart3 or none is possible. Usually UART1 is used for debug port. So prior to changing port, please change uart0 to debug port, or vice versa,


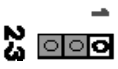
<i>Description</i>	CFG9[1:4]_Base			
	[1]	[2]	[3]	[4]
UART1(usually debug port)	OFF	Don't Care	Don't Care	Don't Care
UART2	ON	OFF	OFF	Don't Care
UART3	ON	ON	Don't Care	Don't Care
IrDA	Don't Care	ON	ON	Don't Care

JUMPER SETTING CONFIGURATION

J23: OP3 POWER SELECT (CPU BOARD)

	OP3_3.3V
	OP3_1.8V


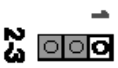
J4: SPI CONNECTION SELECT (BASE BOARD)

	LCD_SPI
	EXT_SPI

▪ Note.

* If you select EXT_SPI, It will be connected with CON9 CONNECTOR.

J5: LCD INTERFACE SELECT (BASE BOARD)

	RGB Interface (LTS222)
	CPU Interface (LTS222)

CONNECTORS

CPU BOARD TYPE1 REV0.0

JTAG

Part Name: J2 (CPU)

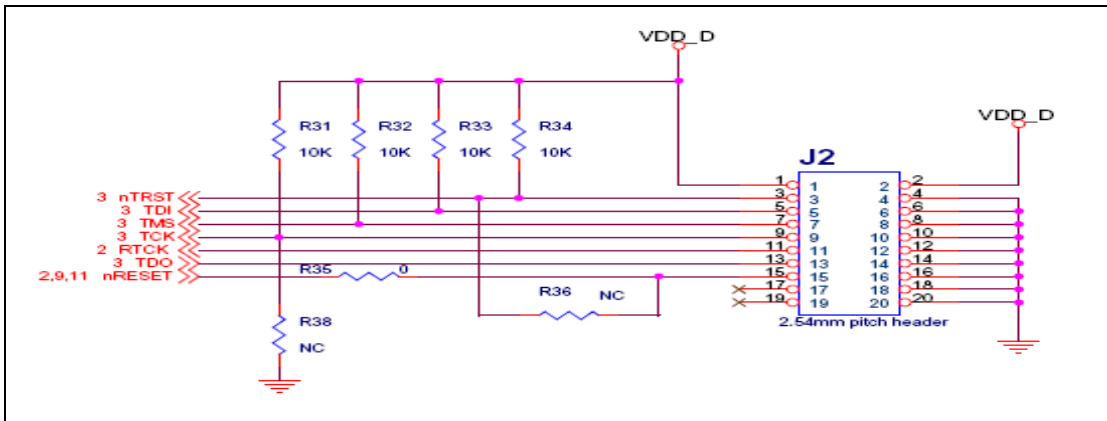


Figure 7 JTAG Connector

USB

Two Dual USB ports A-type (CON2A & CON2B, HOST) and one USB OTG port CON3 B Type and mini AB-type(CON11- TP)are supported by the SMDK 2416.

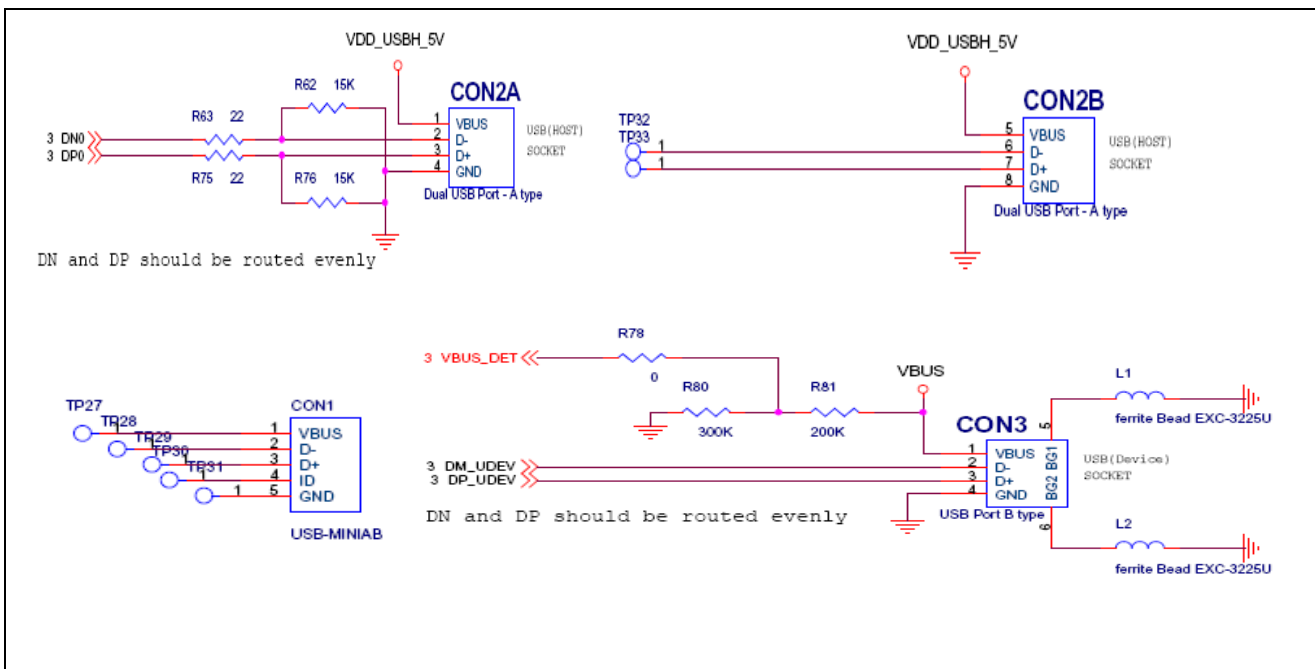


Figure 8 Dual USB ports & OTG port

Hi Speed – SPI

IEEE-1394 connector is used as a Hi Speed- SPI connector

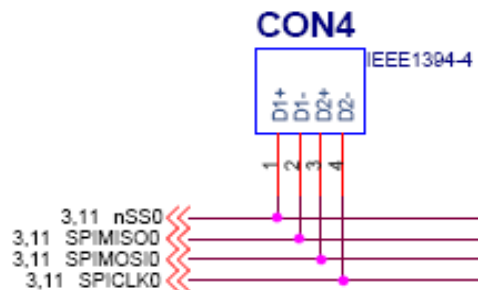


Figure 9 Hi Speed SPI socket(IEEE1394 type)

SD/MMC host (Ver1.0) High speed MMC interface

SD (MMC) is provided by the 2416 and SD card socket (U17) is supported in the SMDK 2416

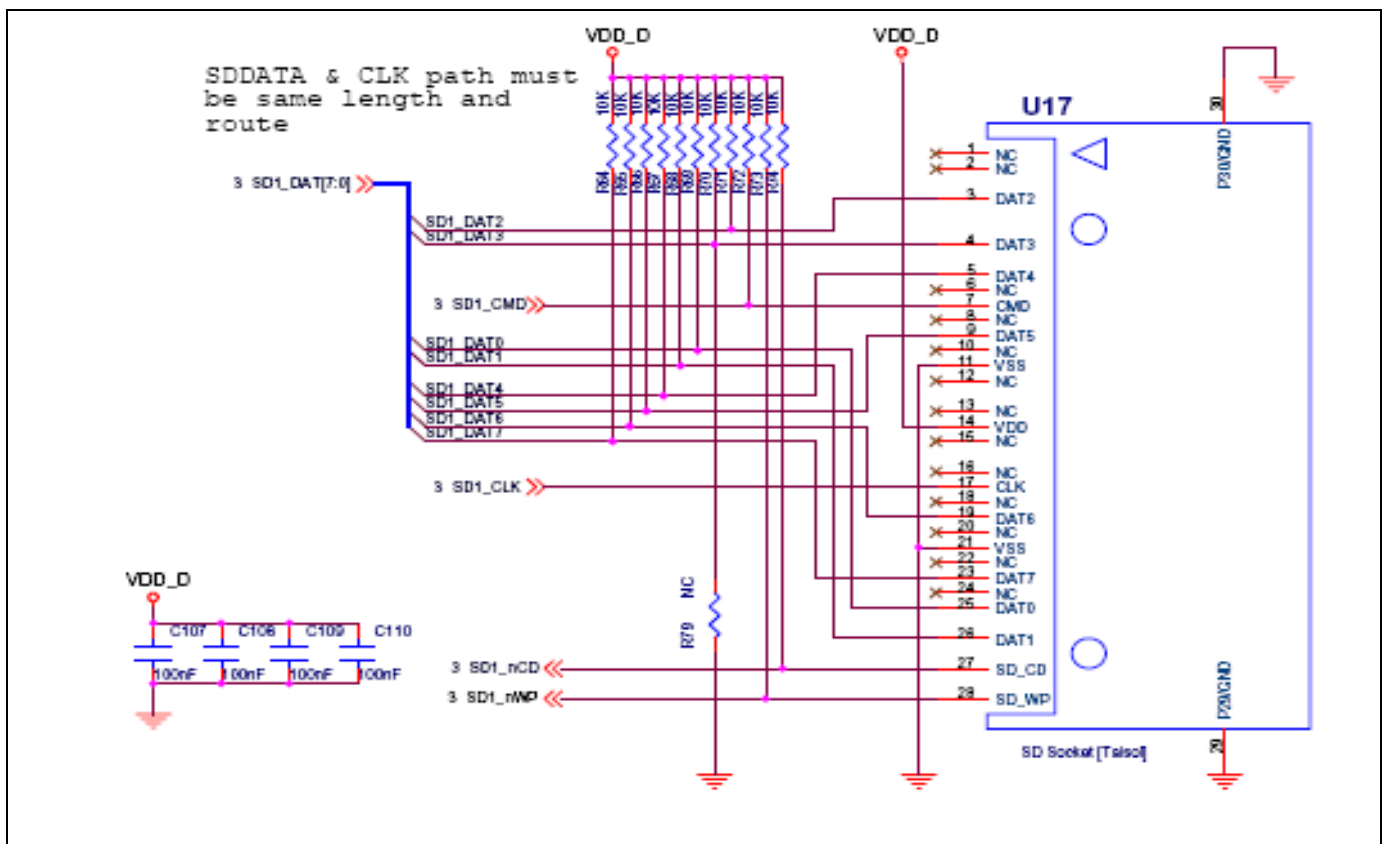


Figure 10 8 Bit SD card Socket

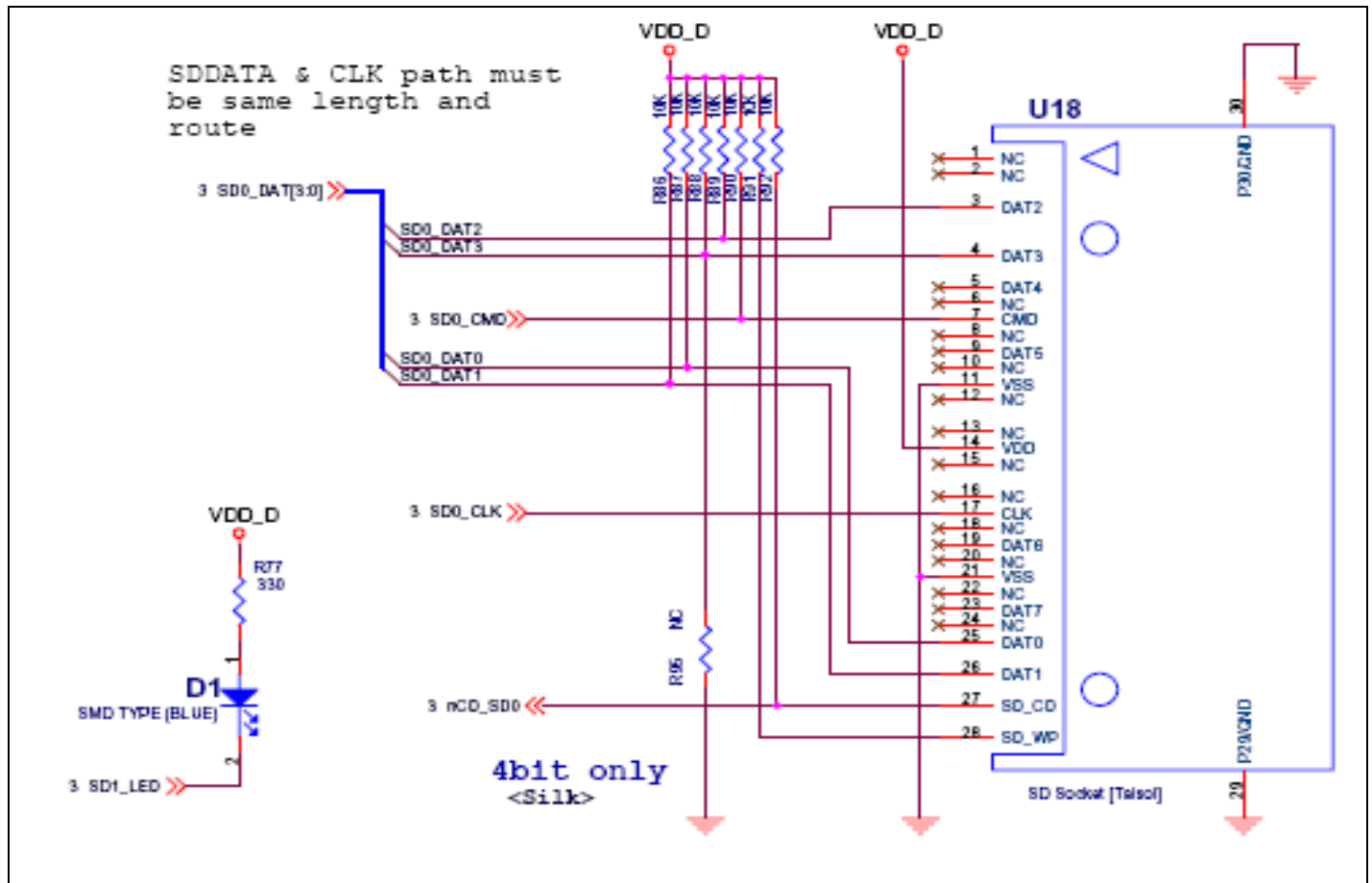


Figure 11 4 Bit SD card Socket

EXTERNAL ONE-NAND connector

External connector is supported for connecting ONE_NAND external board

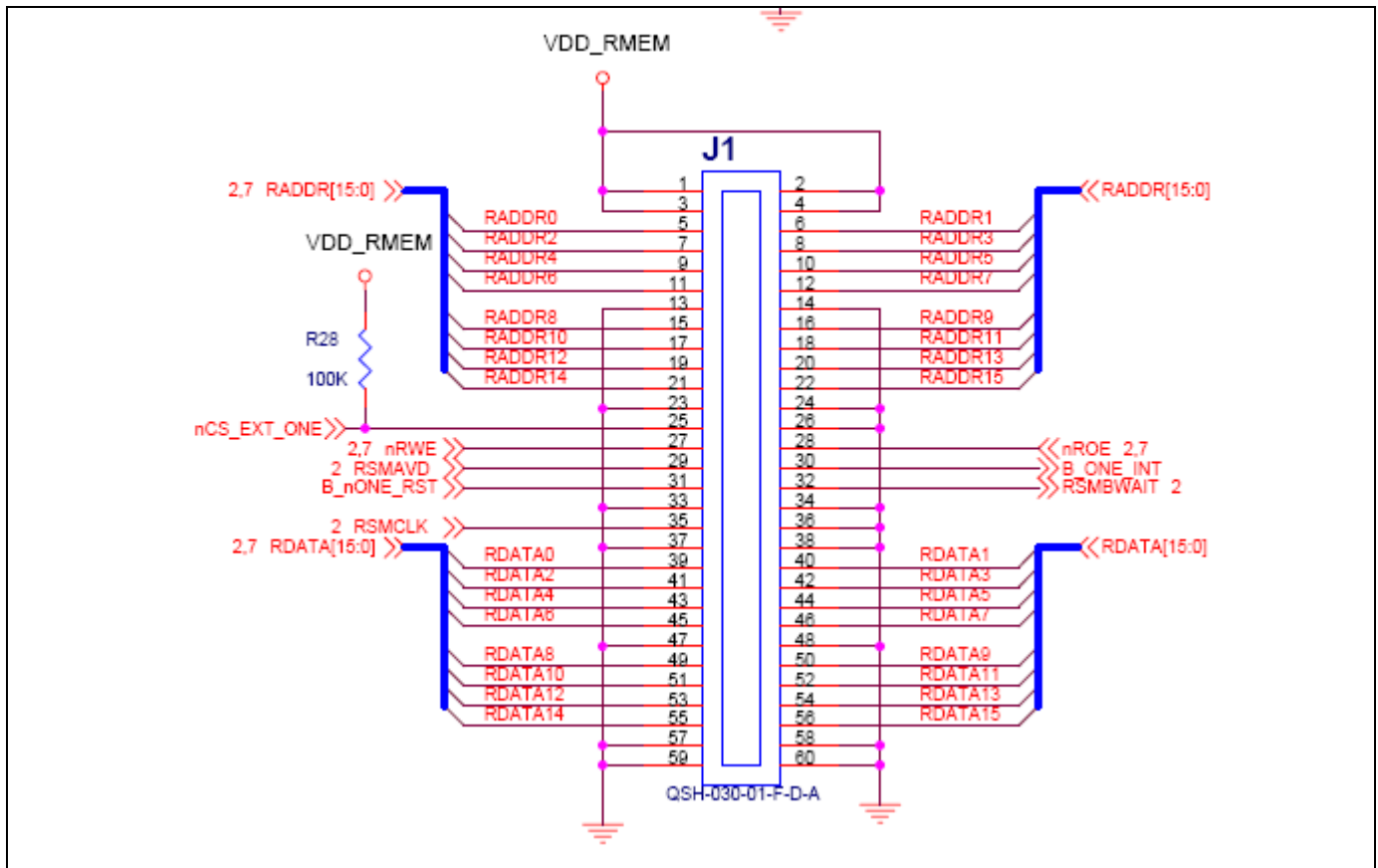


Figure 12 External ONE-NAND B'd Connector

BASE BOARD REV0.0

LINE IN, MIC IN & SPEAKER OUT connector

SMDK 2416 provides LINE IN, MIC IN as an audio connector

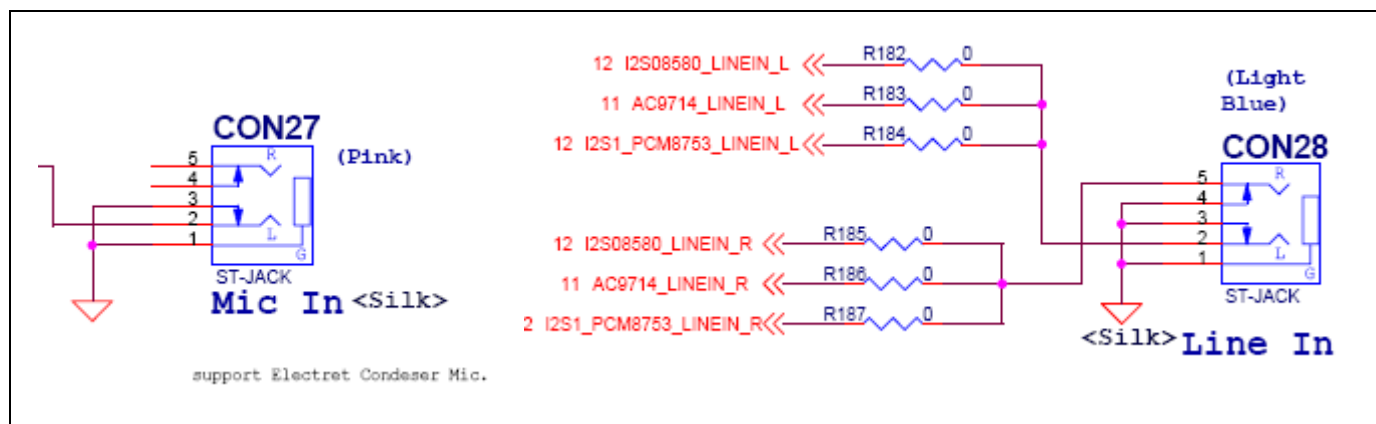


Figure 13 Audio Line In, Mic In Connector

SMDK 2416 provides I2S and AC97 and PCM OUT as an audio connector.

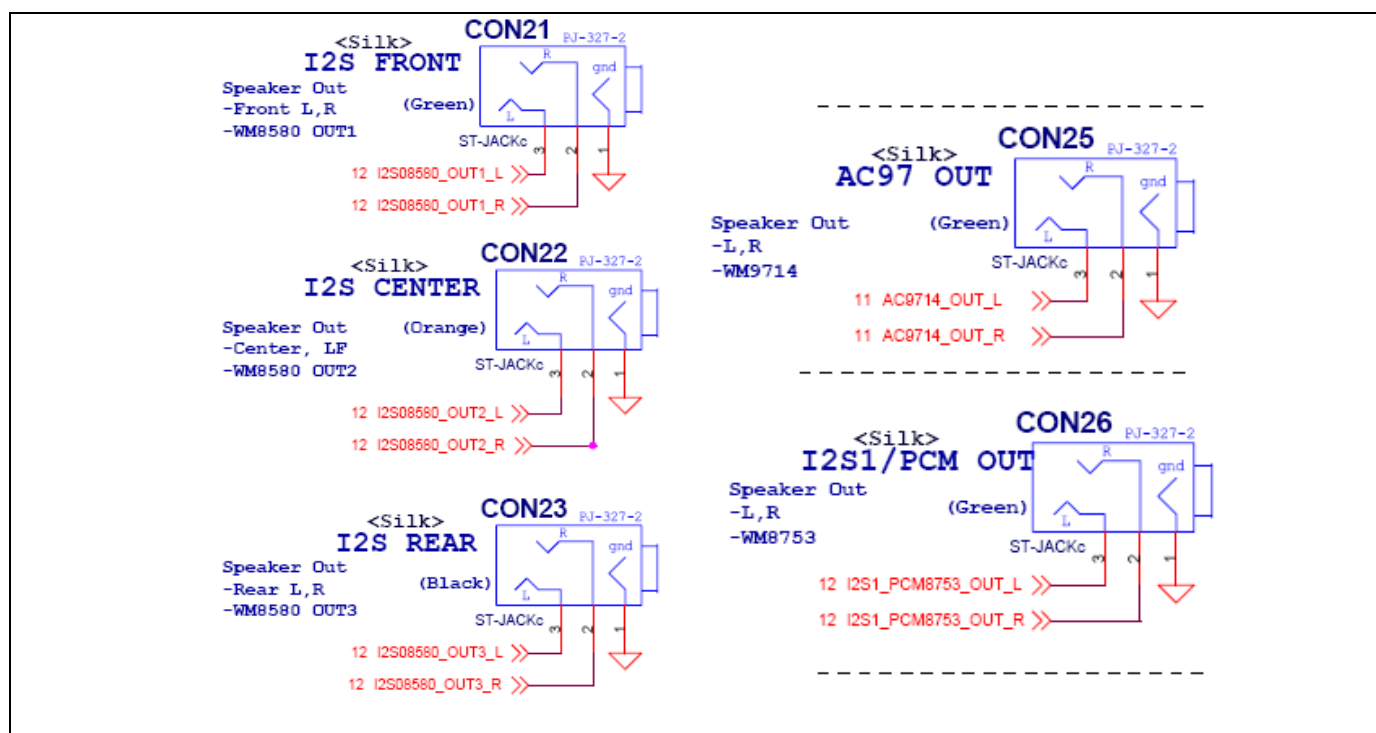


Figure 14 I2S & PCM & AC97 OUT Socket

ETHERNET connector

SMDK 2416 provides Ethernet connector.

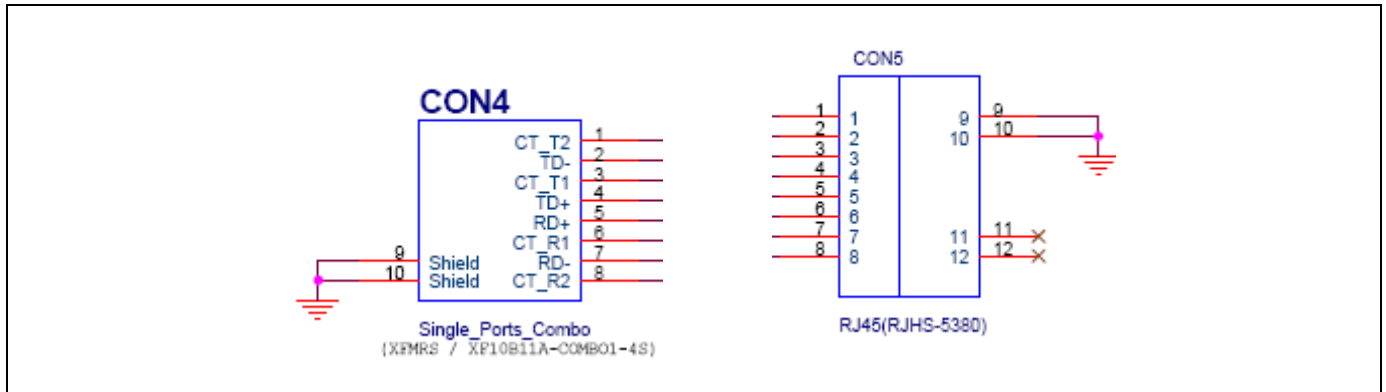


Figure 15 Ethernet Socket

UART interface

The S3C2416 UART unit provides three independent asynchronous serial I/O (SIO) ports including IrDA. In SMDK 2416 board, COM1 port is only used for UART0. No jumper setting is required. You can change UART by setting related jumpers.

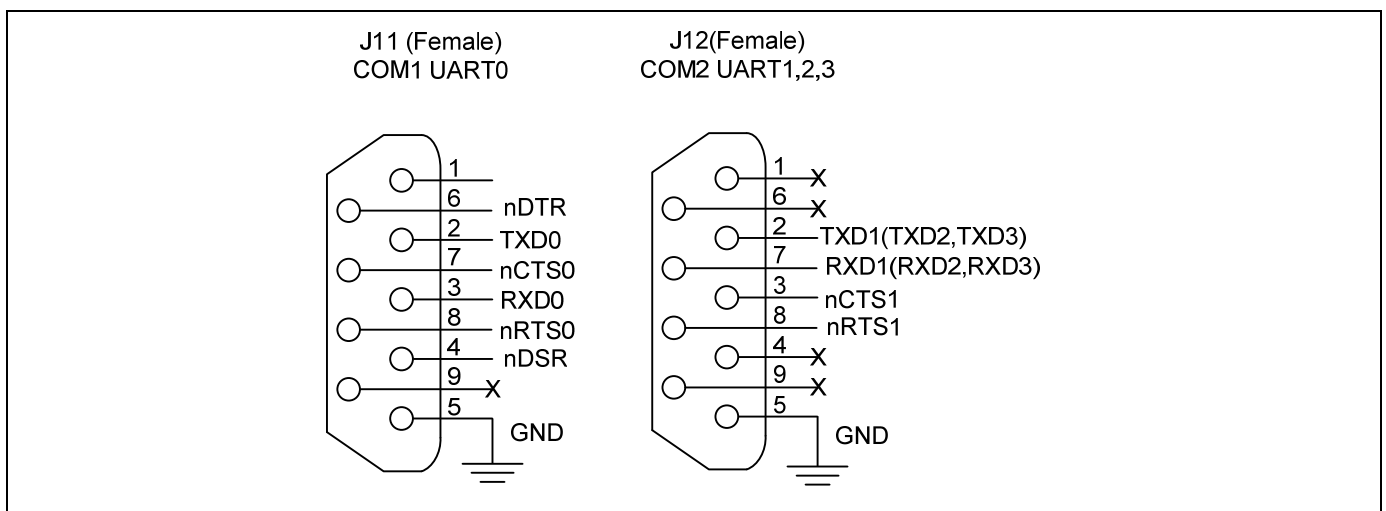


Figure 16 UART Sockets

ADC connector

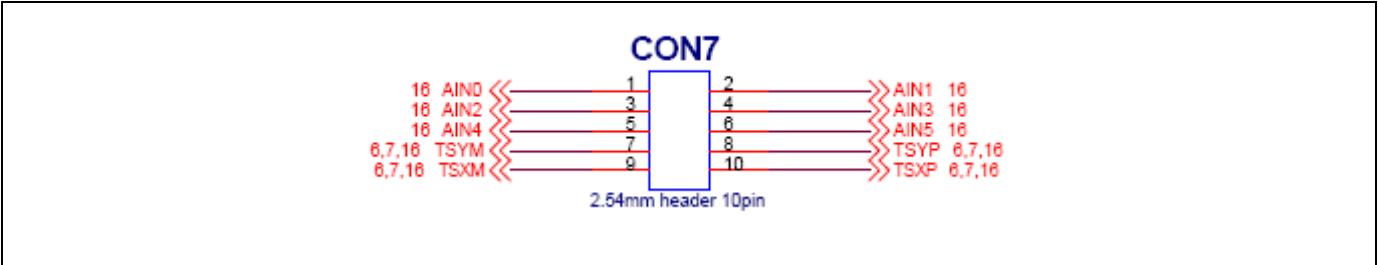


Figure 17 ADC Connector

xD Picture Card Connector

SMDK 2416 provides xD Picture Card Connector.

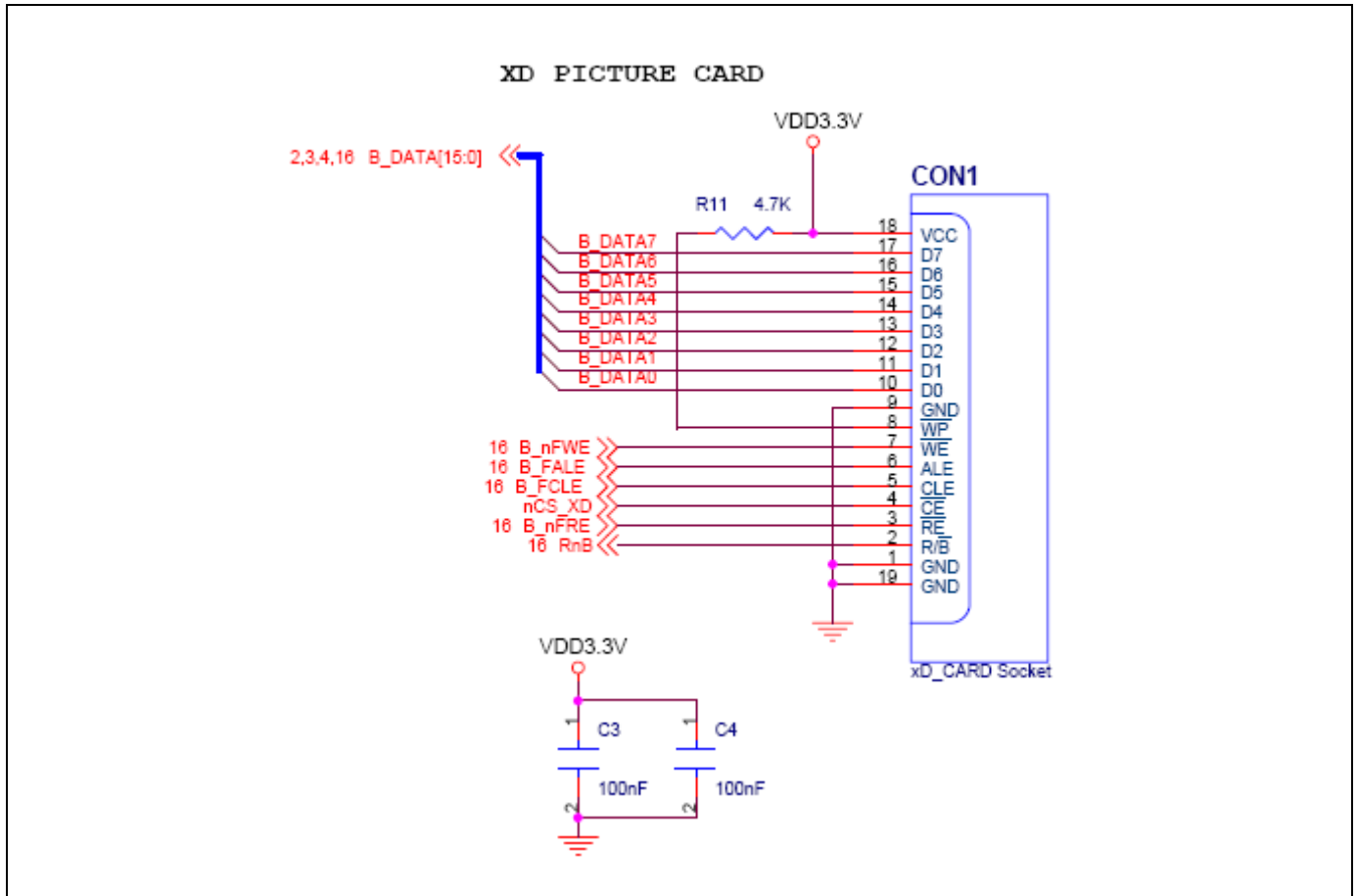


Figure 18 xD Picture Card Socket

TFT LCD Connector

TFT LCD controllers are equipped in the S3C2450X. TFT LCD, touch panel and LCD backlight driver are supported in the SMDK 2416.

Part Name	CON12	CON11	CON13	CON14
Model Name	LTE480WV-F01	LTV350QV_F06	LTS222QV-F01	LTS222QV-F01
Panel Size(pixels)	4.8"(800x480)	3.5"(320x240)	2.22"(240x320)	2.22"(240x320)
I/F type	24bit RGB	24bit RGB + SPI	18/6bit RGB / 16bit i80	16bit i80
Back-Light Unit	14 LED(4pin)	6 LED(2pin)	4 LED(2pin)	4 LED(2pin)
Connector type	45pin(0.5mm pitch)	60pin(0.5mm pitch)	40pin(0.5mm pitch)	40pin(0.5mm pitch)

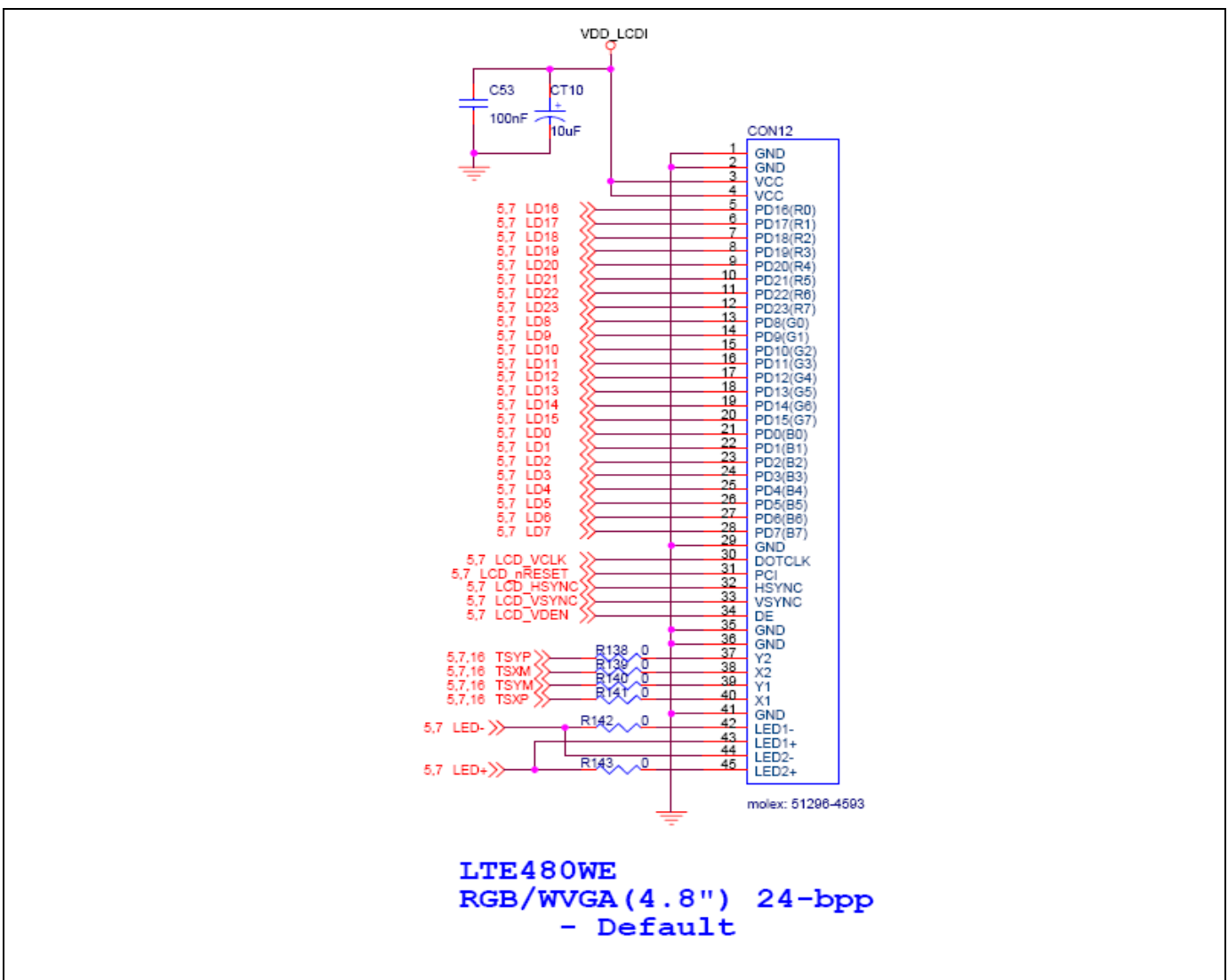


Figure 20 TFT LCD Connector (4.8")

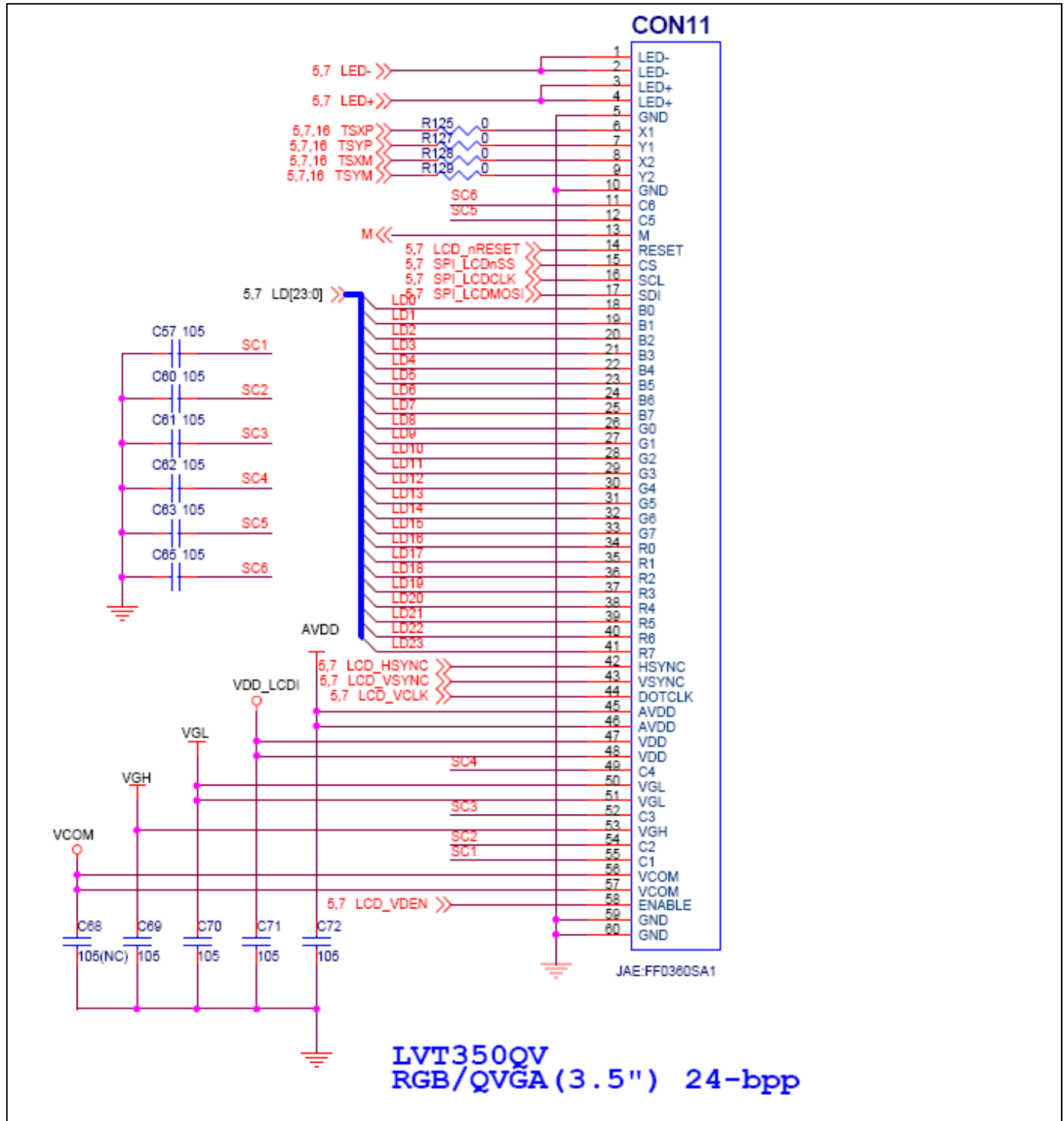


Figure 21 TFT LCD Connector (3.5")

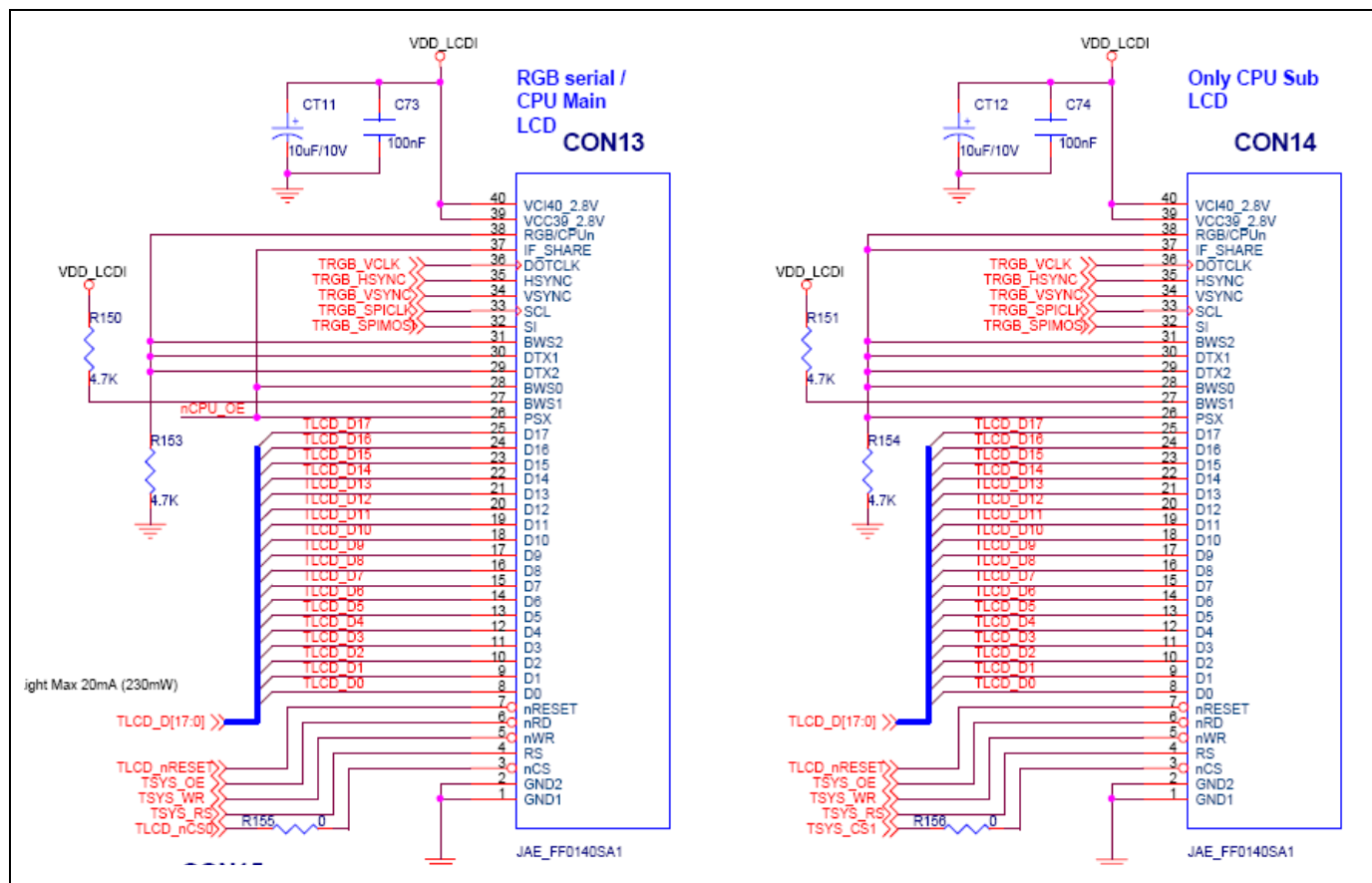


Figure 22 TFT LCD CPU & RGB Type Connector (2.22")

Touch Screen

Part Name: CON15 (BASE)

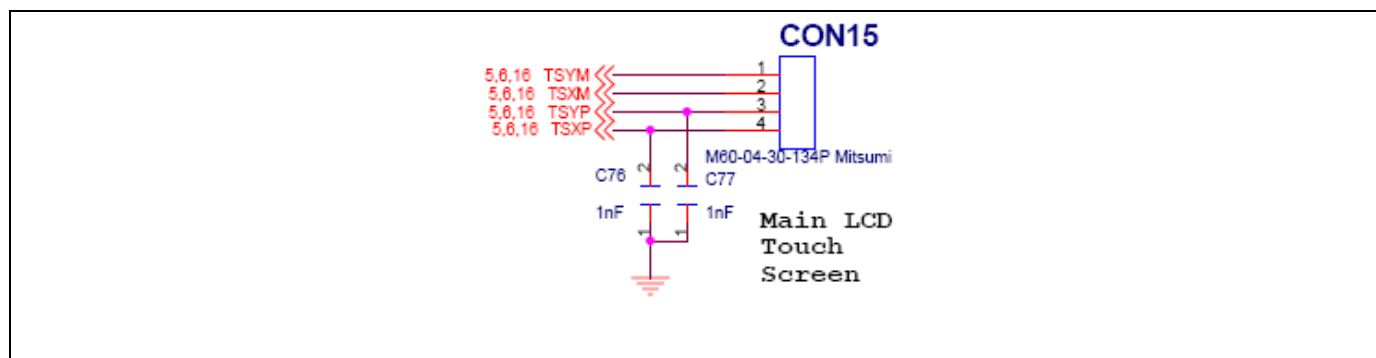


Figure 23 Touch Screen Connector

EXTERNAL CONNECTOR INTERFACE

ROM BUS Interface

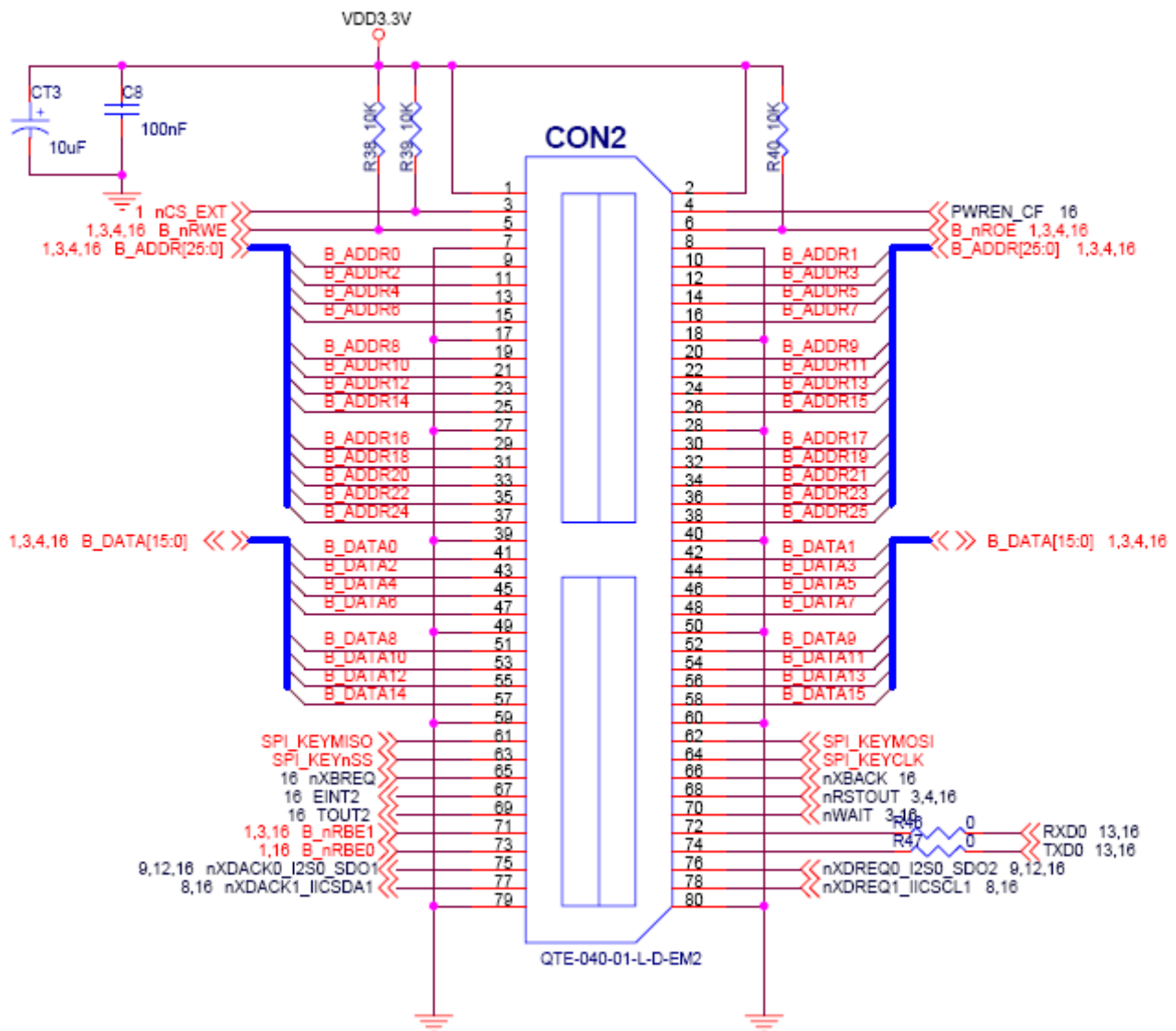


Figure 24 External ROM Bus Connector

# of pin	Descriptions	# of pin	Descriptions	# of pin	Descriptions	# of pin	Descriptions
1	VDD_3.3V	21	B_ADDR10	41	B_DATA0	61	SPI_KEYMISO
2	VDD_3.3V	22	B_ADDR11	42	B_DATA1	62	SPI_KEYMOSI
3	nCS_EXT	23	B_ADDR12	43	B_DATA2	63	SPI_KEYnSS
4	PWREN_CF	24	B_ADDR13	44	B_DATA3	64	SPI_KEYCLK
5	B_nRWE	25	B_ADDR14	45	B_DATA4	65	nXBREQ
6	B_nROE	26	B_ADDR15	46	B_DATA5	66	nXBACK
7	GND	27	GND	47	B_DATA6	67	EINT2
8	GND	28	GND	48	B_DATA7	68	nRSTOUT
9	B_ADDR 0	29	B_ADDR16	49	GND	69	TOUT2
10	B_ADDR 1	30	B_ADDR17	50	GND	70	nWAIT
11	B_ADDR 2	31	B_ADDR18	51	B_DATA8	71	B_nRBE1
12	B_ADDR 3	32	B_ADDR19	52	B_DATA9	72	RXD_0
13	B_ADDR 4	33	B_ADDR20	53	B_DATA10	73	B_nRBE0
14	B_ADDR 5	34	B_ADDR21	54	B_DATA11	74	TXD_0
15	B_ADDR 6	35	B_ADDR22	55	B_DATA12	75	nXDACK0_I2S0_SDO1
16	B_ADDR 7	36	B_ADDR23	56	B_DATA13	76	nXDREQ0_I2S0_SDO2
17	GND	37	B_ADDR24	57	B_DATA14	77	nXDACK1_IICSDA1
18	GND	38	B_ADDR25	58	B_DATA15	78	nXDREQ1_IIC_SCL1
19	B_ADDR 8	39	GND	59	GND-	79	GND
20	B_ADDR 9	40	GND	60	GND	80	GND

CF+ Type II Con.

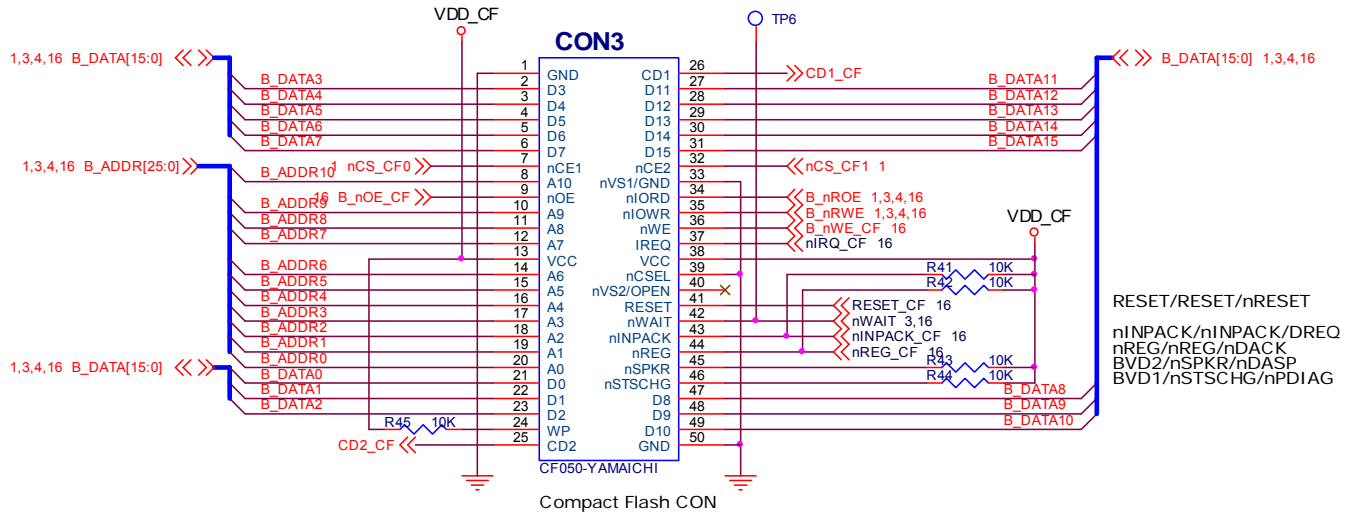


Figure 25 CF+ Type II Con. (SOCKET)

# of pin	Descriptions	# of pin	Descriptions	# of pin	Descriptions	# of pin	Descriptions
1	GND	15	B_ADDR5	29	B_DATA13	43	nINPACK_CF
2	B_DATA3	16	B_ADDR4	30	B_DATA14	44	nREG_CF
3	B_DATA 4	17	B_ADDR3	31	B_DATA15	45	VDD_CF
4	B_DATA 5	18	B_ADDR2	32	nCF_CS1	46	VDD_CF
5	B_DATA 6	19	B_ADDR1	33	GND	47	B_DATA8
6	B_DATA 7	20	B_ADDR0	34	B_nROE	48	B_DATA9
7	nCF_CS0	21	B_DATA0	35	B_nRWE	49	B_DATA10
8	B_ADDR10	22	B_DATA1	36	B_nWE_CF	50	GND
9	B_nOE_CF	23	B_DATA2	37	nIRQ_CF		
10	B_ADDR9	24	VDD_CF	38	VDD_CF		
11	B_ADDR8	25	CD2_CF	39	GND		
12	B_ADDR7	26	CD1_CF	40	-		
13	VDD_CF	27	B_DATA11	41	RESET_CF		
14	B_ADDR6	28	B_DATA 12	42	nWAIT		

PROBE, LOOP-BACK, BOARD TO BOARD CONNECTOR

SMDK 2416 provides Probe, LOOP-BACK, Board to Board connector for debug, functional validation.

Audio Probe, LOOP-BACK, Board To Board connector

To connect between I2S0 and I2S1 for loop-back test, AND(I2S0_SD,SD1,SD2) can be fed to I2S1_SDI with R304 connected.

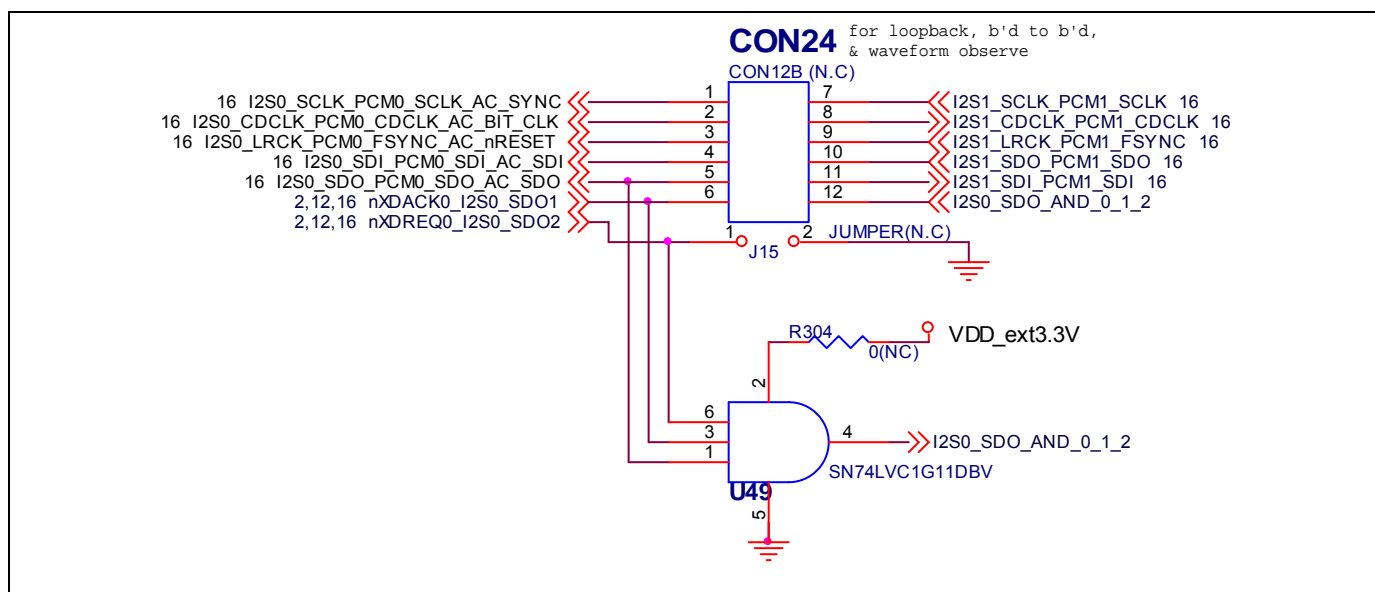


Figure 26 Audio Probe, Loop-back, Board to Board Connector

UART Probe, LOOP-BACK, Board to Board connector

To connect between board and board, disconnect Resistors is recommended for high speed test(over 250kbps)

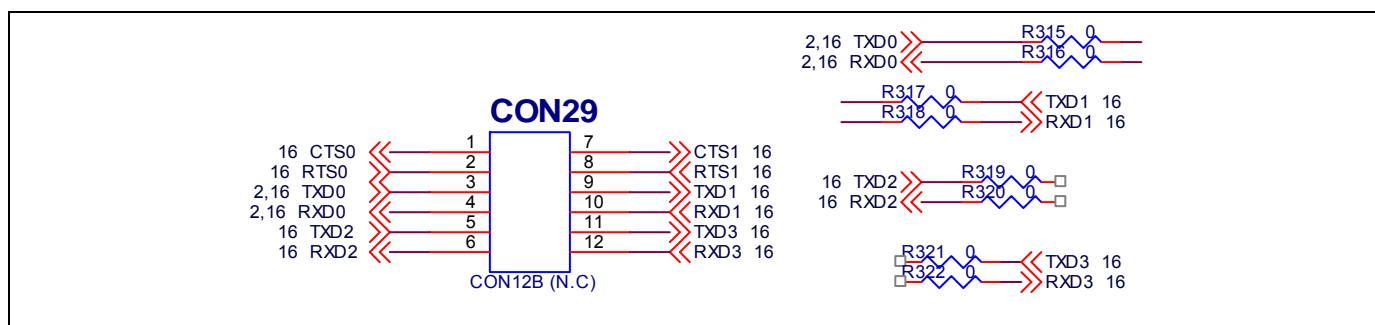


Figure 27 Uart Probe, Loop-back, Board to Board Connector

SMDK SCHEMATIC REVISION POINTS

This document contains information of corrected points on the schematic of SMDK2416. The corrected points are highlighted in red-circled in schematic of SMDK2416 Rev 0.0

REVISION POINTS TABLE

Boards	Page	Contents	Corrected points
CPU Board			
Base Board			

SMDK SCHEMATIC

There are 2 parts of SMDK2416 Schematic.

1. CPU Board
2. Base Board

Note. It is easy to find schematic parts by using **Bookmarks** on PDF